ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® Material	Composition De 2005. IPC, Bannockl and Pan-American co	claration burn, Illinois. A opyright conver	Il rights reserved u ntions.	nder both	This docume level parts, t	ent is a declaration entities the declaration entities and the declaration entities and the declaration entities and the declaration entities are an entities and the declaration entities are an entities and the declaration entities are an entite are an entities are an entities are an entite are	on of the substar acompasses all 1	ces within the ma	nufacturer liss lls for which t	ted item. Note:	if the item is an as r has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Typ			Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				s Materials an	ials and Mfg Information			
upplier Information													
Company name*			Company unique ID			Unique ID Authority				Response Date*			
nsemi									2025-08-02				
Contact Name Title -			Title - Contact			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Pro			Product Enviro Compliance			NA			Pro	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title			Title - Representative			Phone - Representative*			Ema	Email - Representative*			
roduct-Env-Stewards	Product Enviro Compliance				NA			Pro	Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr Iten		n Number Mfr Item Name				Effective Date	Version	Manufacturing	Site	Weight*	UOM	Unit Type	
	EGP10B	EGP10B HER DO41 GP		PN 1A 100V		2025-08-02 TSCE		TSCBE	ſSCBE		mg	Each	
Ianufacturing Proccess In	formation												
Terminal Plating / Grid Array Material Termi		Ferminal Base A	Il Base Alloy J-STD-020 MSI		Rating	Peak Process Body Temperate		ature Max Time	at Peak Tem	perature Num	per of Reflow Cy	cles	
Matte Tin (Sn) - annealed		CU Alloy NA		NA		0 C 30		S	seconds 3				
omments													
or more information regarding n	naterial composition	please refer to	page 3										

RoHS Material Composition Declar	ation			Declaration Type *	Detailed
Directive 2015/863/EU amending Rol Directive 2011/65/EU	(Pb), Mercury (Hg), Hexav		ninated Biphenyls (PBB), Polybror	dmium and quantity limit of 0.1% by mass (100 ninated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polyb contains a RoHS restricted substance i encompass all such components.Suppl as of the date that Supplier completes Company acknowledges that Supplier independently verified information pro- certification in this paragraph.If the Co	rominated biphenyls and/or polybror nexcess of an applicable quantity lim ier certifies that it gathered the inforr this form.Supplier acknowledges that may have relied on informationprovi ovided by others, Supplier agrees that ompany and the Supplier enter into a clusivesource of the Supplier's liabili	ninated diphenyl ethers (each a "R it, please indicate below which, if nation it provides in this form usin Company will rely on this certifud ded by others in completing this f , at a minimum, itssuppliers have written agreement with respect to ty and the Company's remedies for	toHS restricted substance") in exce any, RoHS exemption you believe ag appropriate methods to ensure it cation in determining the complian orm, and that Supplier may not hav provided certifications regarding th the identified part,the terms and co or issues that arise regarding inform	ropean Union member states) of the part identifies so of the applicable quantity limit identified about may apply. If the part is an assembly with lows a accuracy and that such information is true and ce of its products with European Union member re independently verified such information. How heir contributions to the part, and those certifica motions of that agreement, including any warra nation the Supplier provides in this form. In the	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the inty rights and/or remedies provided as part of
RoHS Declaration * 4	- Item(s) does not contain RoHS restr	icted substances per the definition	above except for selected exempti	ons Supplier Acceptance	* Accepted
Exemption: 7a: Lead in high meltin Exemption: 7c-I Electrical and elect	g temperature type solders (i.e. lead ronic components containing lead i	l based solder alloys containing n a glass or ceramic other than	85% by weight or more lead). dielectric ceramic in capacitors, o	e.g. piezoelectronic devices, or in a glass or ce	eramic matrix compound.
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the rec Requester) and click on Submit For			Supplier Acceptance drop-down	. This will display the signature area. Digital	ly sign the declaration (if required by the
Supplier Digital Signature	Rastislav Drska	Le			

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.095	mg	Supplier	Silicon (Si)	7440-21-3		0.9855	mg
			В	Nickel (Ni)	7440-02-0		0.0071	mg
			Supplier	Gold (Au)	7440-57-5		0.0016	mg
			Supplier	Lead Bisilicate	65997-18-4	7c	0.1007	mg
Die Attach Solder	3.5	mg	Supplier	Silver (Ag)	7440-22-4		0.0875	mg
			А	Lead (Pb)	7439-92-1	7a	3.2375	mg
			Supplier	Tin (Sn)	7440-31-5		0.175	mg
Lead Wire	294.8	mg	Supplier	Iron (Fe)	7439-89-6		0.2358	mg
			Supplier	Copper (Cu)	7440-50-8		294.5052	mg
			Supplier	Phosphorus (P)	7723-14-0		0.059	mg
Marking Ink	0.2	mg	Supplier	Silicon Dioxide (SiO2)	112945-52-5		0.01	mg
			Supplier	1-Hydroxycyclohexyl phenyl ketone	947-19-3		0.01	mg
			Supplier	Padimate (C14H21NO2)	21245-01-2		0.02	mg
			Supplier	2-Propenoic acid polymer	53192-18-0		0.13	mg
			Supplier	Aluminum (Al)	7429-90-5		0.03	mg
Mold Compound-Black	38.0	mg		Metal Hydroxide	proprietary data		1.786	mg
			Supplier	Carbon Black (C)	1333-86-4		0.114	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		30.4	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		3.8	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.9	mg
Plating	2.4	mg	Supplier	Tin (Sn)	7440-31-5		2.4	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).